

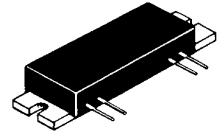
**MHW806A  
 SERIES**

**The RF Line**  
**UHF Power Amplifier Module**

... designed for 12.5 Volt UHF power amplifier applications in industrial and commercial FM equipment operating from 806 to 950 MHz.

- MHW806A1 820–850 MHz
- MHW806A2 806–870 MHz
- MHW806A3 890–915 MHz
- MHW806A4 870–950 MHz
- Specified 12.5 Volt, UHF Characteristics
  - Output Power = 6 Watts
  - Minimum Gain = 23 dB (MHW806A1,2)
  - = 21.7 dB (MHW806A3,4)
  - Harmonics = -42 dBc Max (2f<sub>O</sub>)
  - = -60 dBc Max (3f<sub>O</sub> and Higher)
- 50 Ω Input/Output Impedances
- Guaranteed Stability and Ruggedness
- Features Three Common-Emitter Gain Stages
- Epoxy Glass PCB Construction Gives Consistent Performance and Reliability
- Gold-Metallized and Silicon Nitride-Passivated Transistor Chips
- Controllable, Stable Performance Over More Than 35 dB Range in Output Power

**HIGH GAIN RF POWER  
 AMPLIFIER MODULE**  
**6 WATTS**  
**806–950 MHz**



CASE 301H-02

**MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
DC Supply Voltages	V <sub>S1</sub>	16	Vdc
RF Input Power	P <sub>in</sub>	80	mW
RF Output Power	P <sub>out</sub>	7.5	W
Storage Temperature Range	T <sub>stg</sub>	-30 to +100	°C
Operating Case Temperature Range	T <sub>C</sub>	-30 to +100	°C
DC Control Voltage	V <sub>Cont</sub>	12.5	Vdc

**ELECTRICAL CHARACTERISTICS** (Flange Temperature = 25°C, 50 Ω system, and V<sub>S1</sub> = 12.5 V unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
Frequency Range MHW806A1 MHW806A2 MHW806A3 MHW806A4	BW	820 806 890 870	— — — —	850 870 915 950	MHz
Power Gain (V <sub>Cont</sub> = 12.5 Vdc, P <sub>out</sub> = 6 W)	G <sub>p</sub>	23 21.7	24 22.7	— —	dB
Efficiency (1) (P <sub>out</sub> = 6 W)	η	30	35	—	%
Harmonic Output (1) (P <sub>out</sub> = 6 W Reference)	—	— —	— —	-42 -60	dBc
Input VSWR (1) (P <sub>out</sub> = 6 W, 50 Ω Reference, Reflected Signal Filtered to Eliminate Harmonic Content)	—	—	—	2:1	—

(1) P<sub>in</sub> = 30 mW (MHW806A1,2) or P<sub>in</sub> = 40 mW (MHW806A3,4), adjust V<sub>Cont</sub> for specified P<sub>out</sub>.

(continued)



## ELECTRICAL CHARACTERISTICS — continued

(Flange Temperature = 25°C, 50 Ω system, and  $V_{S1} = 12.5$  V unless otherwise noted)

Characteristic		Symbol	Min	Typ	Max	Unit
Power Degradation (-30 to +80°C) (1) (Reference $P_{Out} = 6$ W @ $T_C = 25$ °C)		—	—	—	1.7	dB
Load Mismatch Stress (1) ( $V_{S1} = 16$ Vdc, $P_{Out} = 7.5$ W, VSWR = 30:1, all phase angles)		—	No degradation in Power Output			
Stability ( $P_{In} = 0$ to 30 mW, [MHW806A1,2] or 0 to 40 mW [MHW806A3,4], $V_{S1} = 10$ to 16 Vdc, $V_{Cont} = 0$ to 12.5 Vdc, Load VSWR = 4:1, $P_{Out}$ Max = 7.5 W) (2)		—	All spurious outputs $\geq 70$ dB below desired output signal level			
Quiescent Current @ $V_{Cont} = 12.5$ V ( $I_{Cont}$ with no RF drive applied)		$I_{Cont}$	—	—	225	mA
Control Voltage	$P_{In} = 30$ mW (MHW806A1,2), $P_{In} = 40$ mW (MHW806A3,4) $P_{Out} = 6$ W $V_{Cont} = 12.5$ V	$V_{Cont}$	0	9	12.5	Vdc
Control Current		$I_{Cont}$	0	155	225	mA

(1)  $P_{In} = 30$  mW (MHW806A1,2) or  $P_{In} = 40$  mW (MHW806A3,4) adjust  $V_{Cont}$  for specified  $P_{Out}$ .

(2) Combination of  $P_{In}$ ,  $V_{S1}$ , and  $V_{Cont}$  can not exceed max  $P_{Out} = 7.5$  W.

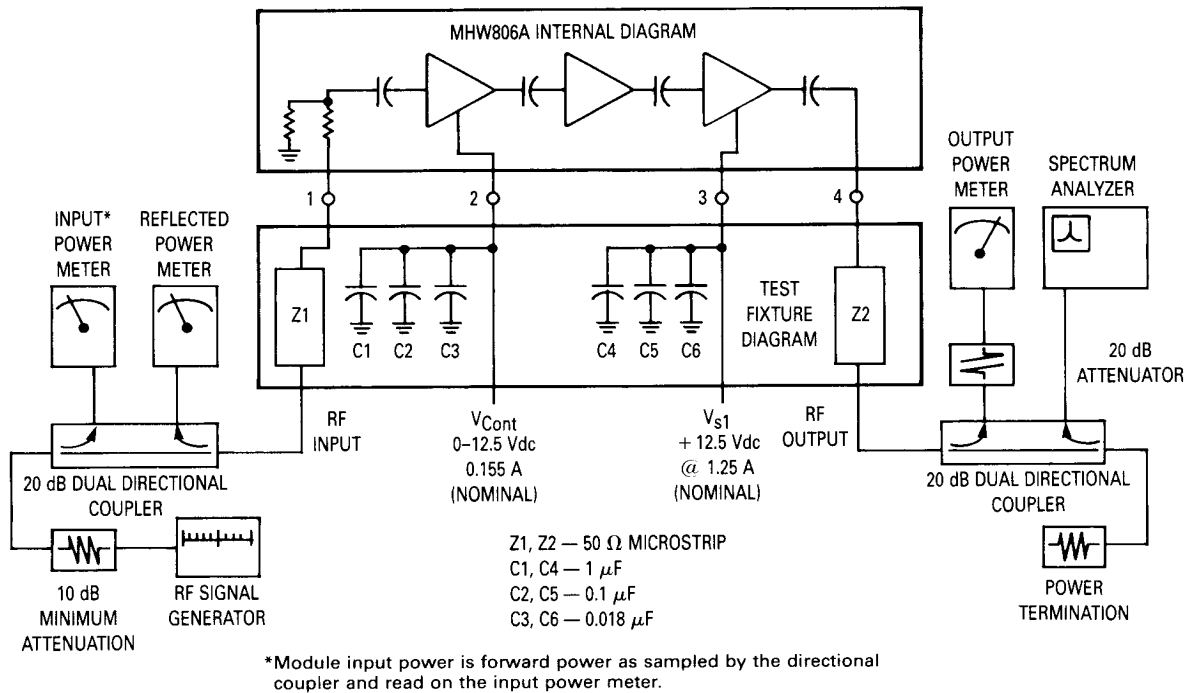


Figure 1. UHF Power Module Test System Diagram

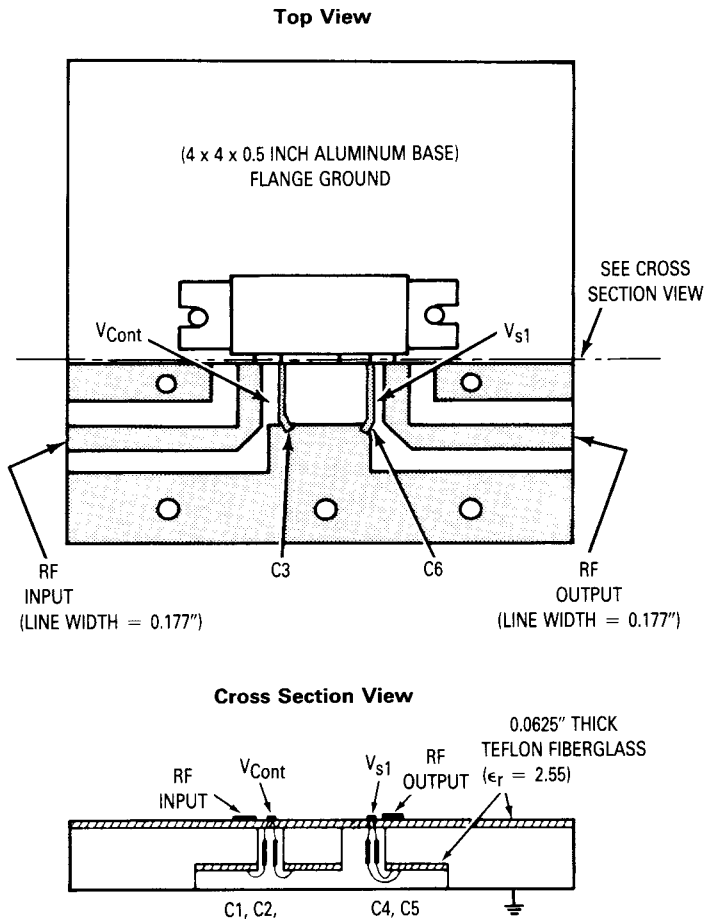
## APPLICATIONS INFORMATION

### Nominal Operation

All electrical specifications are based on the following nominal conditions: ( $P_{out} = 6 \text{ W}$ ,  $V_{S1} = 12.5 \text{ Vdc}$ ). This module is designed to have excess gain margin with ruggedness, but operation outside the limits of the published specifications is not recommended unless prior communications regarding the intended use have been made with a factory representative.

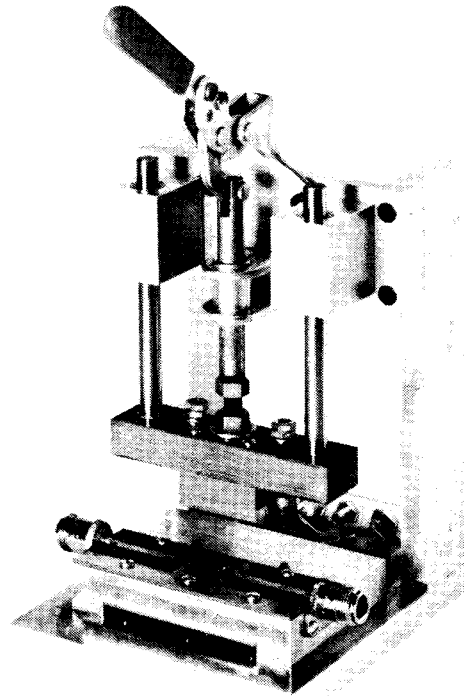
### Gain Control

In general, the module output power should be limited to 7.5 watts. The preferred method of power output control is to fix  $V_{S1}$  at 12.5 volts, set RF drive level and vary the control voltage from 0 to 12.5 Volts. As designed, the module exhibits a gain control range greater than 35 dB using the method described above.



Bring capacitor leads through fiberglass board and solder to  $V_{S1}$  and  $V_{Cont}$  lines as close to module as possible.

**Figure 15. Test Fixture Construction**



**Figure 14. Test Fixture Assembly**

### Decoupling

Due to the high gain of each of the three stages and the module size limitation, external decoupling networks require careful consideration. Both Pins 2 and 3 are internally bypassed with a  $0.018 \mu\text{F}$  chip capacitor which is effective for frequencies from 5 MHz through 960 MHz. For bypassing frequencies below 5 MHz, networks equivalent to that shown in the test fixture schematic are recommended. Inadequate decoupling will result in spurious outputs at specific operating frequencies and phase angles of input and output VSWR.

### Load Mismatch Stress

During final test, each module is load mismatch stress tested in a fixture having the identical decoupling network described in Figure 1. Electrical conditions are  $V_{S1}$  equal to 16 volts, load VSWR 30:1 and output power equal to 7.5 watts.

### Mounting Considerations

To insure optimum heat transfer from the flange to heatsink, use standard 6–32 mounting screws and an adequate quantity of silicone thermal compound (e.g., Dow Corning 340). With both mounting screws finger tight, alternately torque down the screws to 4–6 inch pounds. The heatsink mounting surface directly beneath the module flange should be flat to within 0.0015 inch. For more information on module mounting, see EB-107.

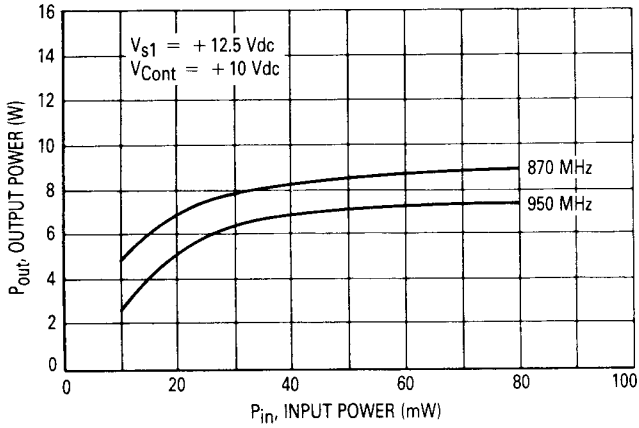


Figure 8. Output Power versus Input Power

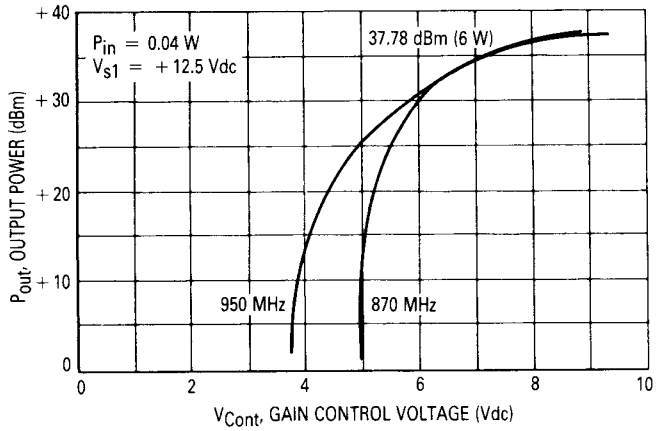


Figure 9. Output Power versus Gain Control Voltage

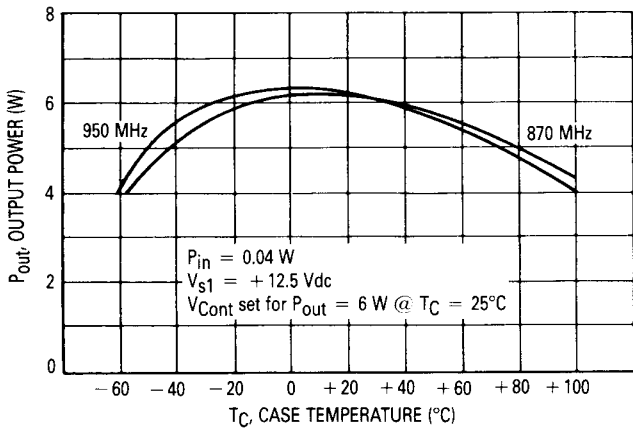


Figure 10. Output Power versus Case Temperature

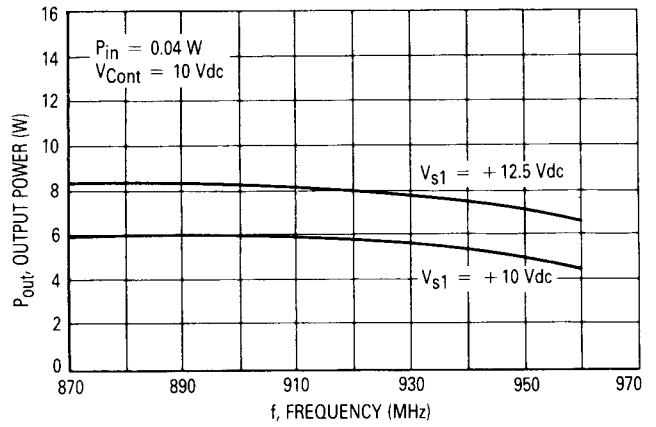


Figure 11. Output Power versus Frequency

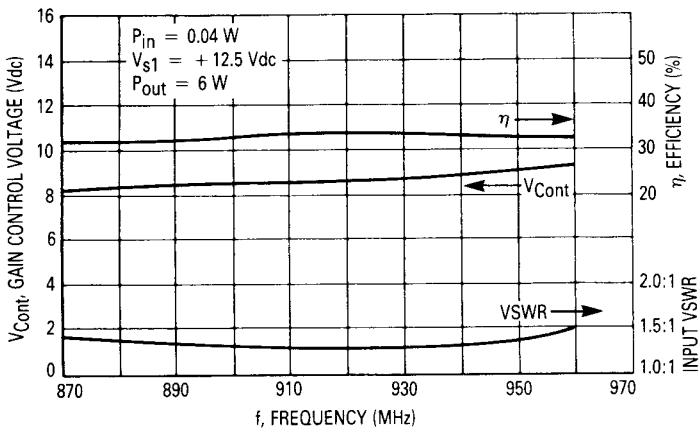


Figure 12. Gain Control Voltage, Input VSWR, Efficiency versus Frequency

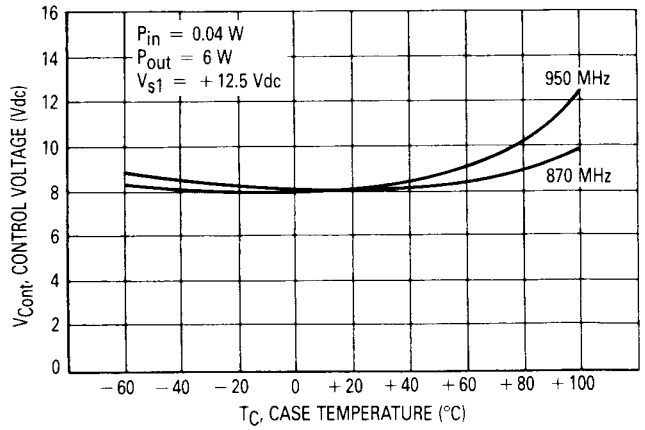


Figure 13. Gain Control Voltage versus Case Temperature

# MHW806A1, A2

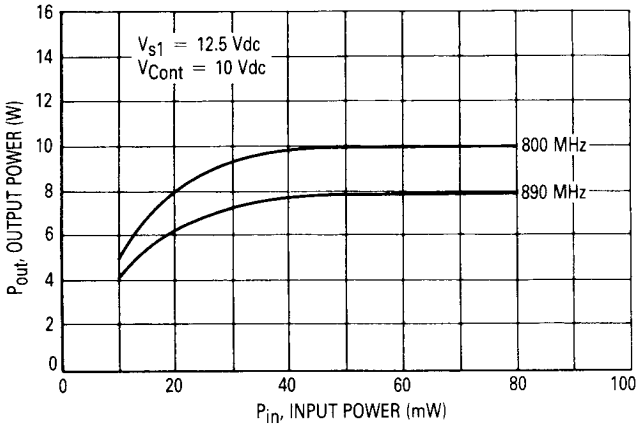


Figure 2. Output Power versus Input Power

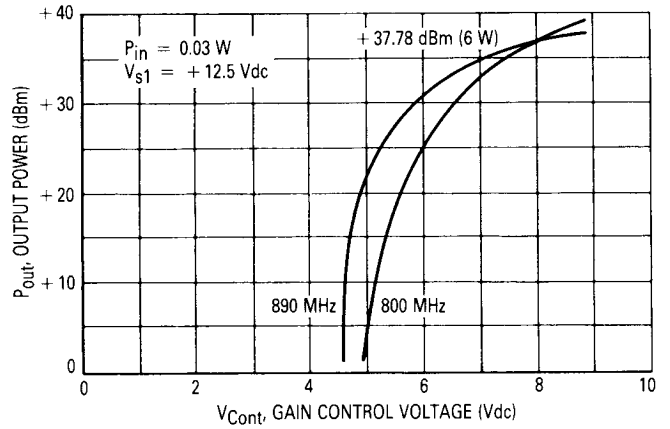


Figure 3. Output Power versus Gain Control Voltage

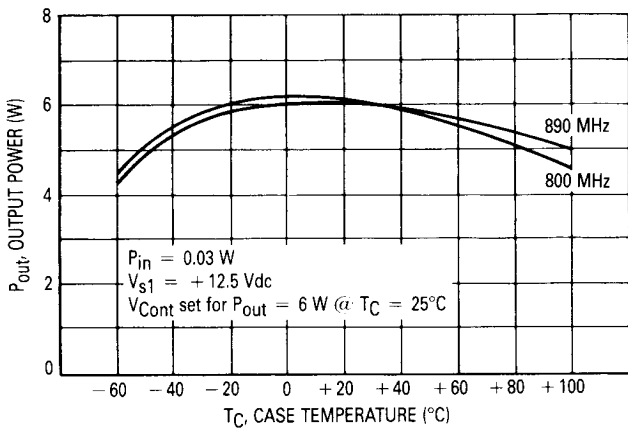


Figure 4. Output Power versus Case Temperature

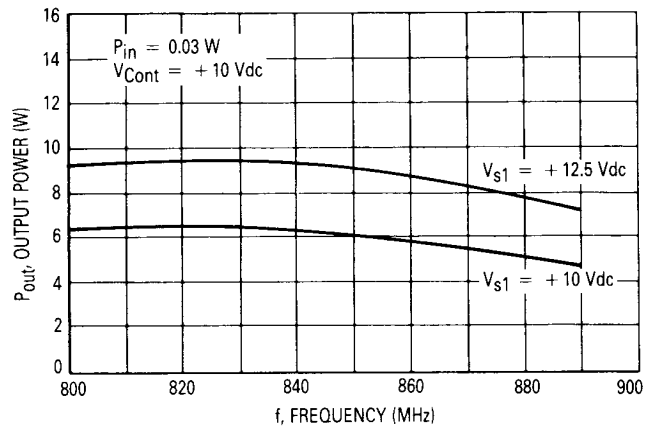


Figure 5. Output Power versus Frequency

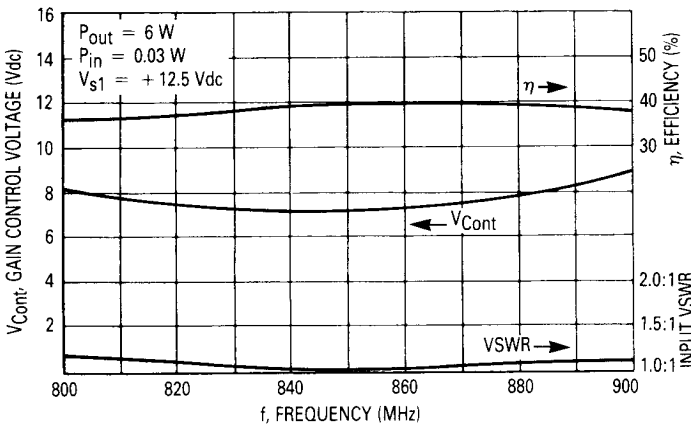


Figure 6. Gain Control Voltage, Input VSWR, Efficiency versus Frequency

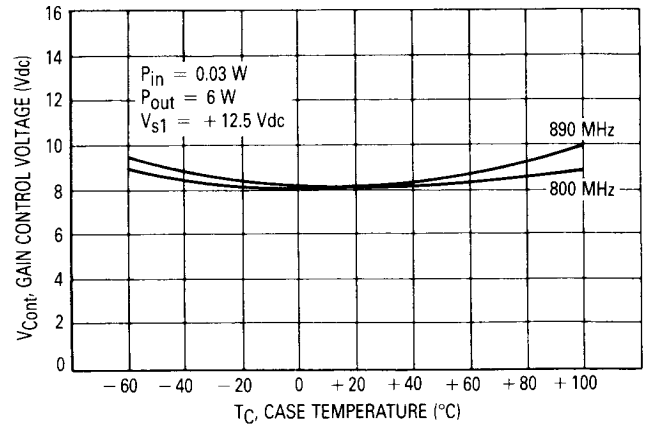
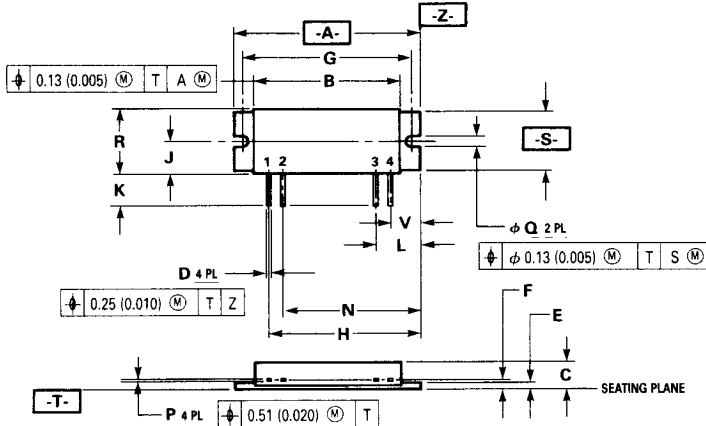


Figure 7. Gain Control Voltage versus Case Temperature

# OUTLINE DIMENSIONS

## CASE 301H-02



STYLE 1:  
 PIN 1. RF INPUT  
 2. + DC (CONTROL)  
 3. + DC (SUPPLY)  
 4. RF OUTPUT  
 CASE: GROUND

- NOTES:  
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
 2. CONTROLLING DIMENSION: INCH.  
 3. DIMENSION F TO CENTER OF LEADS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	48.01	48.51	1.890	1.910
B	29.72	30.22	1.170	1.190
C	8.89	9.55	0.350	0.376
D	0.46	0.55	0.018	0.022
E	3.05	3.42	0.120	0.135
F	4.06 BSC		0.160 BSC	
G	40.64 BSC		1.600 BSC	
H	35.56 BSC		1.400 BSC	
J	8.77	9.77	0.345	0.385
K	5.72	—	0.225	—
L	17.78 BSC		0.700 BSC	
N	33.02 BSC		1.300 BSC	
P	0.21	0.30	0.008	0.012
Q	3.81	4.06	0.150	0.160
R	17.40	19.55	0.685	0.770
S	15.12	15.49	0.595	0.610
V	12.70 BSC		0.500 BSC	

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MHW806A SERIES

16

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